

UNISONIC TECHNOLOGIES CO., LTD

6NM45 **Preliminary Power MOSFET**

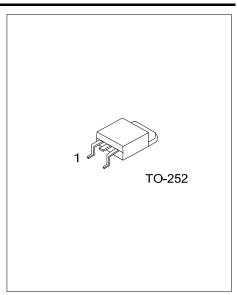
6.0A, 450V N-CHANNEL SUPER-JUNCTION MOSFET

DESCRIPTION

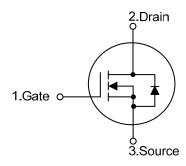
The UTC 6NM45 is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

FEATURES0

- * $R_{DS(ON)} \le 0.75 \Omega$ @ $V_{GS}=10V$, $I_D=3.0A$
- * Low on-resistance
- * High Switching Speed
- * 100% Avalanche Tested



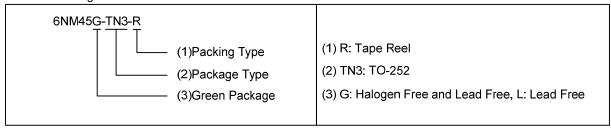
SYMBOL



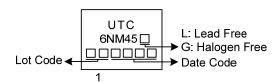
ORDERING INFORMATION

Ordering Number		Daalaaaa	Pin Assignment			D. alain a	
Lead Free	Halogen Free	Package	1	2	3	Packing	
6NM45L-TN3-R	6NM45G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



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■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	450	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I _D	6	Α
	Pulsed (Note 2)	I _{DM}	18	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	324	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.4	V/ns
Power Dissipation		P _D	21	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 144mH, I_{AS} = 2.1A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 6.0 A$, di/dt $\le 200 A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25 ^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θ_{JA}	110	°C/W	
Junction to Case	θις	5.95	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

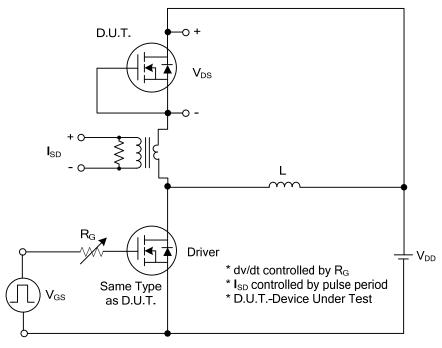
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT			
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	450			V			
Drain-Source Leakage Current	I _{DSS}	V _{DS} =450V, V _{GS} =0V			10	μΑ			
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V			±100	nA			
ON CHARACTERISTICS									
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.5		4.5	V			
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =3.0A			0.75	Ω			
DYNAMIC CHARACTERISTICS									
Input Capacitance	Ciss			230		pF			
Output Capacitance	Coss	V _{DS} =50V, V _{GS} =0V, f=1MHz		142		pF			
Reverse Transfer Capacitance	C_{RSS}			14		pF			
SWITCHING CHARACTERISTICS									
Total Gate Charge (Note 1)	Q_{G}	V _{DS} =50V, V _{GS} =10V, I _D =3.0A Note 1, 2)		17		nC			
Gate-Source Charge	Q_GS			5		nC			
Gate-Drain Charge	Q_GD			7		nC			
Turn-On Delay Time (Note 1)	$t_{D(ON)}$			7		ns			
Turn-On Rise Time	t_R	V _{DD} =100V, V _{GS} =10V,		22		ns			
Turn-Off Delay Time	t _{D(OFF)}	I _D =6.0A, R _G =25Ω (Note 1, 2)		31		ns			
Turn-Off Fall Time	t_{F}]		21		ns			
SOURCE- DRAIN DIODE RATINGS AND CHA	ARACTERISTI	CS							
Maximum Continuous Drain-Source Diode					6	Α			
Forward Current	Is				O	А			
Maximum Pulsed Drain-Source Diode	I_{SM}				18	Α			
Forward Current	ISM				10				
Drain-Source Diode Forward Voltage (Note 1)	V_{SD}	I _S =6.0A, V _{GS} =0V			1.4	V			
Body Diode Reverse Recovery Time (Note 1)	t _{rr}	I _S =6.0A, V _{GS} =0V,		206		nS			
Body Diode Reverse Recovery Charge	Q_{rr}	dI _F /dt=100A/μs		1.7		μ C			

Notes: 1. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%.

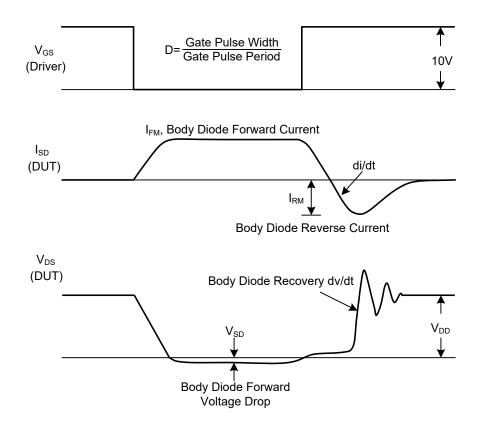
^{2.} Essentially independent of operating temperature.



■ TEST CIRCUITS AND WAVEFORMS

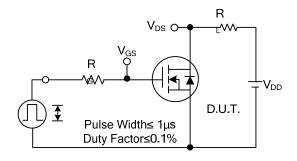


Peak Diode Recovery dv/dt Test Circuit

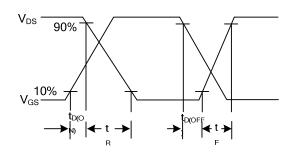


Peak Diode Recovery dv/dt Waveforms

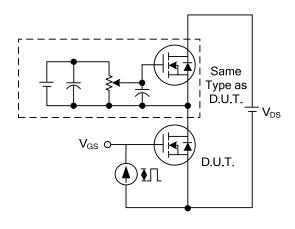
■ TEST CIRCUITS AND WAVEFORMS



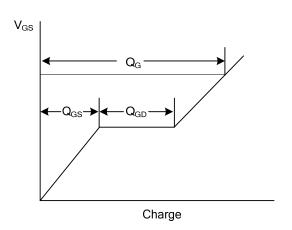
Switching Test Circuit



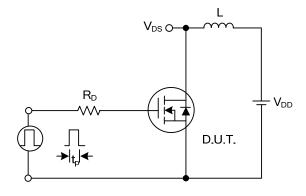
Switching Waveforms



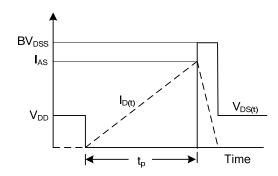
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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